

### General Description

The MAX3905 evaluation kit (EV Kit) is an assembled demonstration board that provides electrical and optical evaluation of the MAX3905 150Mbps Automotive VCSEL Driver. All output current settings are adjustable by jumpers.

## ♦ Fully Assembled and Tested

- Easy Selection of Operating Modes
- ♦ Includes 3-Pin Socket for VCSEL Insertion

## **Component List**

**DESIGNATION QTY DESCRIPTION**  $0.047\mu F \pm 10\%$  ceramic 2 C1, C2 capacitors (0402) 0.1μF ±10% ceramic C3-C5, C9 4 capacitors (0402) 0.1uF ±10% ceramic C6 1 capacitor (0603)  $0.47\mu F \pm 10\%$  ceramic C8 1 capacitor (0603) 2 C10, C11 Not Installed C22 1 10μF tantalum capacitor 0.01µF ±10% ceramic C23 capacitor (0603) SMA connectors, tab J1-J4 contact, edge mount J18, J19, TP1-Test points 7 TP3, TP5, TP7 Digi-Key 5000K-ND JP1. JP3. JP5 -JP13, 2-pin headers, 0.1in centers JP16, JP17 3-pin + 1-pin header, 0.1in JP2 1 centers JP18 VCSEL (Not Installed) 1 1µH inductor 1 L1 Coilcraft 1008CS-102XKB R1, R11-R13  $49.9\Omega \pm 1\%$  resistors (1206) R2, R5, R9 3  $49.9\Omega \pm 1\%$  resistors (0603) R3 1  $16.2k\Omega \pm 1\%$  resistor (0603) R4 1  $29.4k\Omega \pm 1\%$  resistor (0603) R6 1  $10k\Omega \pm 1\%$  resistor (0603) R7 1  $4.99\Omega \pm 1\%$  resistor (0603) R10 Not Installed 1 MAX3905\* (packaged in 32 U1 1 QFN for EV Kit only) MAX3905 evaluation circuit None board, rev A MAX3905 data sheet None

\*Note: U1 has an exposed pad, which requires it to be solder attached to the circuit board to ensure proper functionality of the part.

### \_ Ordering Information

Features

PART	TEMP. RANGE	IC PACKAGE
MAX3905EVKIT	-40°C to +140°C**	32 QFN

\*\*Junction Temperature for die; EV Kit materials should not be heated beyond 85°C.

## Component Suppliers

SUPPLIER	PHONE	FAX
AVX	843-448-9411	843-448-1943
Digi-Key	218-681-6674	218-681-3380
Murata	770-436-1300	770-436-3030

**Note:** Please indicate that you are using the MAX3905 when ordering from these suppliers.

### \_ Quick Start

### Electrical Evaluation

- Connect a +3.3V or +5V supply to J19 and ground to J18.
- Apply 10Mbps to 50Mbps data to IN\_TTL (J1) or 50Mbps to 150Mbps data to IN+ and IN- (J2 and J3).
- If TTL data is applied, leave jumper JP1 (DIFF) open. If differential data is applied, shunt jumper JP1.
- 4) Shunt jumper JP3 to provide bias to the OUT pad.
- Shunt jumper JP2 (3DB) in the "Normal Power" position.
- 6) Adjust jumpers JP5 JP13 to change the output current as desired.

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#### **Optical Evaluation**

- Connect a +3.3V or +5V supply to J19 and ground to J18.
- Apply 10Mbps to 50Mbps data to IN\_TTL (J1) or 50Mbps to 150Mbps data to IN+ and IN- (J2 and J3).
- If TTL data is applied, leave jumper JP1 (DIFF) open. If differential data is applied, shunt jumper JP1.
- 4) Replace resistor R6 with a  $0\Omega$  resistor and remove resistor R5 and capacitor C4.
- 5) Solder a VCSEL at JP18, with the cathode of the VCSEL in the hole connected to R6 and the anode in either of the two other holes. Components R10 and C10 may be installed if necessary to compensate the VCSEL lead inductance.
- Shunt jumper JP2 (3DB) in the "Normal Power" position.
- 7) Adjust jumpers JP5 JP13 to change the output current as desired.

## **Jumper and Test Point Descriptions**

NAME	TYPE	SHUNT POSITION	DESCRIPTION
DIFF (JP1)	2-pin header	OPEN	Enables TTL data input IN_TTL
		SHUNT (GND)	Enables differential data inputs IN+ and IN-
	2 min t	OPEN O O O	Enables low power mode
		NORMAL POWER	Enables normal power mode
	3-pin + 1-pin header	LOW POWER	Connects 3DB pad to VCC with a 29.4k $\Omega$ resistor. Enables low power mode when 4.75V $\leq$ VCC $\leq$ 5.25V.
		NORMAL POWER 5V 0 0 0	Connects 3DB pad to VCC with a 16.2kΩ resistor. Enables normal power mode when 4.75V ≤ VCC ≤ 5.25V.
JP3	2-pin header	OPEN	For electrical evaluation, a bias voltage $0.9V \le V_{BIAS} \le VCC$ should be applied at this jumper to turn on the output stage
		SHUNT (VCC)	Applies an output stage bias voltage of VCC
DT01 and DT02	2-pin headers	OPEN	Sets the DT0 bit low
(JP5 and JP6)		SHUNT (VCC)	Sets the DT0 bit high
MOD1 and MOD2 (JP8 and JP7)	2-pin headers	OPEN	Sets the MOD bit low
		SHUNT (VCC)	Sets the MOD bit high
	2-pin	OPEN	Sets the TC bit low
	headers	SHUNT (GND)	Sets the TC bit high
LOW1 and LOW2 (JP12 and JP13)	2-pin headers	OPEN	Sets the LOW bit low
		SHUNT (GND)	Sets the LOW bit high
SQEN (JP16)	2-pin header	OPEN	Enables squelch
		SHUNT (GND)	Disables squelch
TEMPSENS (TP1)	Test Point	-	Monitors voltage on the TEMPSENS pad, corresponding to the junction temperature of the die.

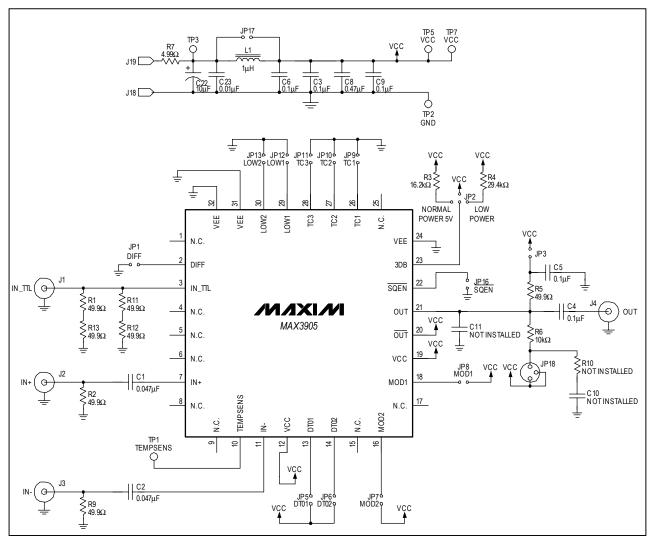


Figure 1. MAX3905 EV Kit Schematic

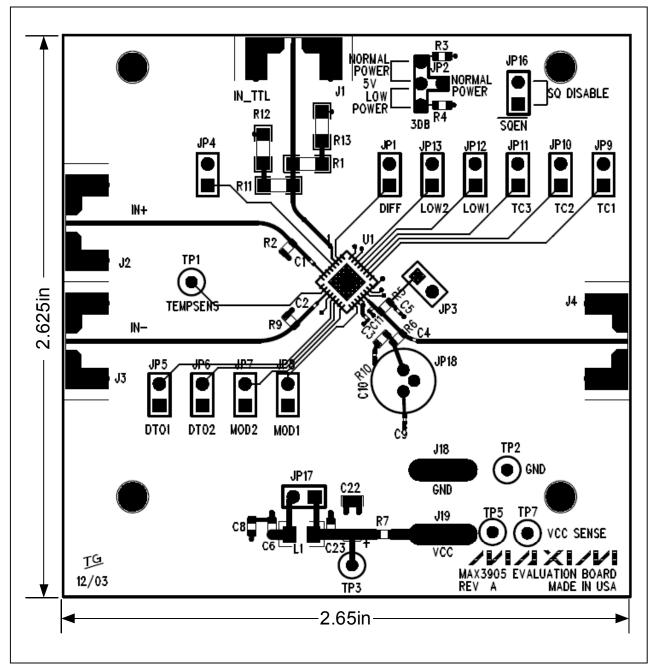


Figure 2. MAX3905 EV Kit Component Placement Guide - Component Side

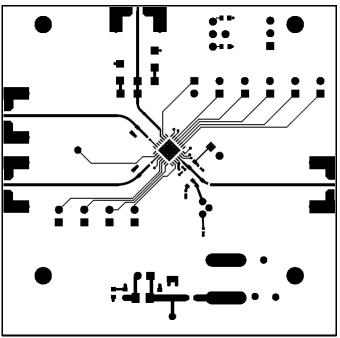


Figure 3. MAX3905 EV Kit PC Board Layout - Component Side

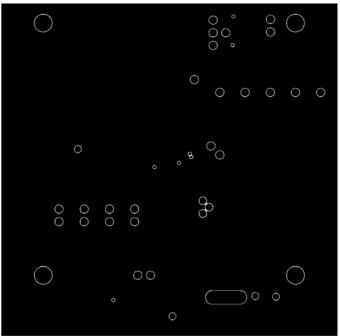


Figure 4. MAX3905 EV Kit PC Board Layout – Ground Plane

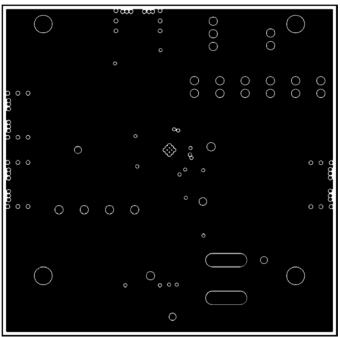


Figure 5. MAX3905 EV Kit PC Board Layout – Power Plane

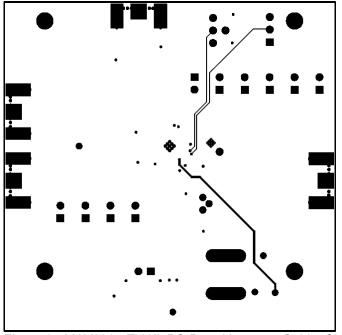


Figure 6. MAX3905 EV Kit PC Board Layout - Solder Side

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